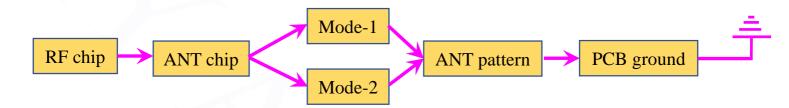
P/N: HY160808 SRF09

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Features:

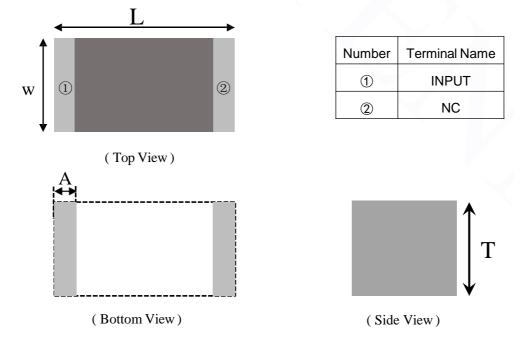
- 1. Surface mounted element with a small dimension of $1.6 \times 0.8 \times 0.8$ mm meet future miniaturization trend.
- 2. Embedded and LTCC (low temperature co-fired ceramic) technology is able to integrate with system design as well as beatifying the housing of final product.
- 3. Miniaturization, wideband, high stability, low ESR, and low tolerance.
- 4. Dual-band resonances in the dominant and harmonic modes enables multiband operations.
- 5. Novel ground-radiation technique enables radiation from both the antenna and the ground plane.



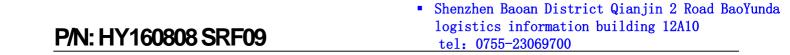
✓ Applications:

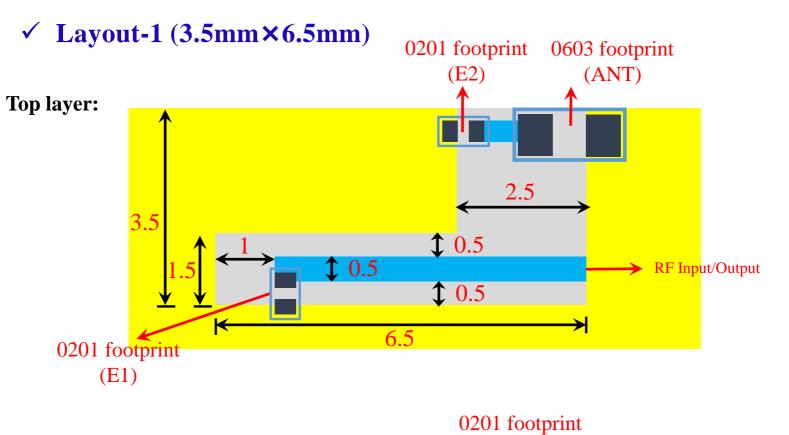
- 1. Bluetooth
- 2. Dual-band WLAN
- 3. ISM and UWB

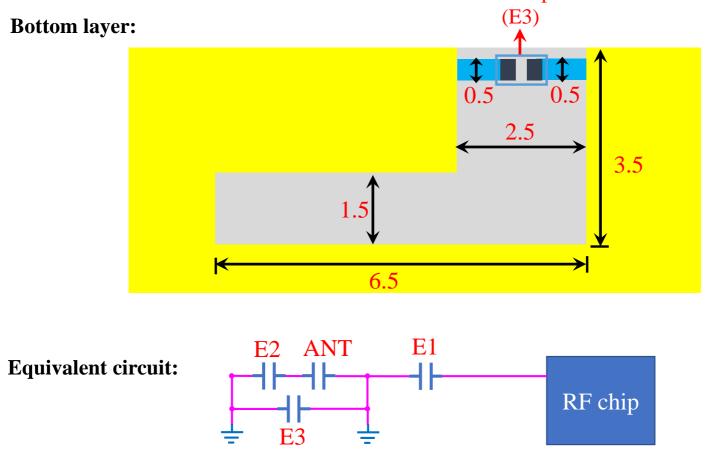
✓ Dimensions (Unit: mm)

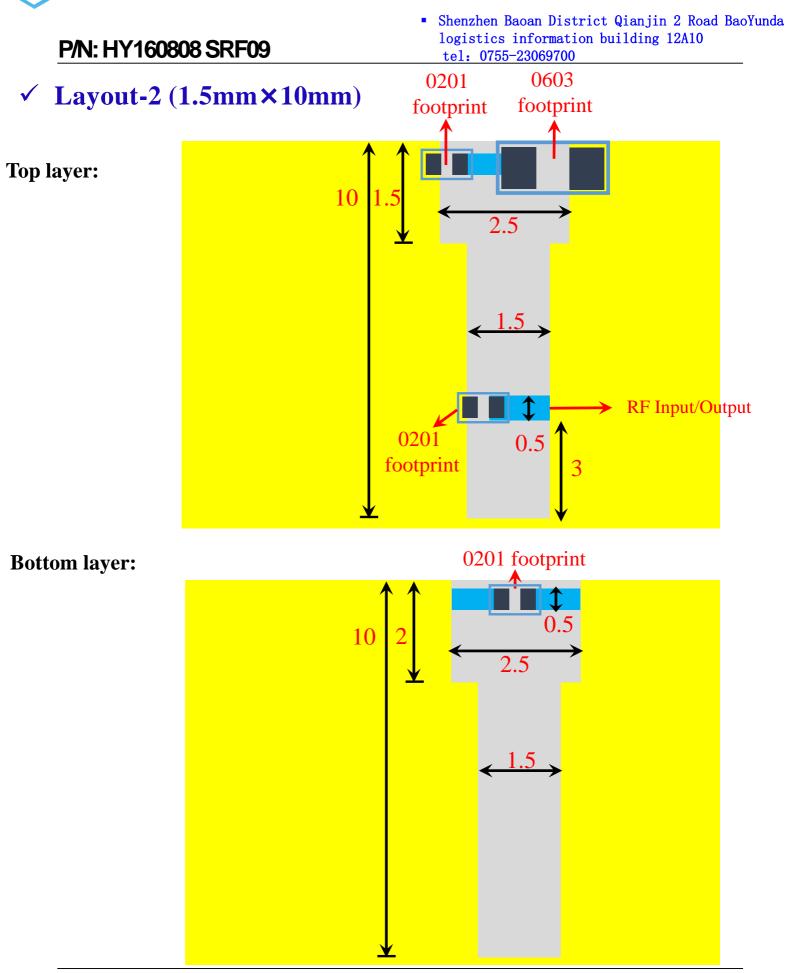


Symbols	L	W	Т	А
Dimensions	1.60 ± 0.20	0.80 ± 0.20	0.80 ± 0.20	0.30 ± 0.10



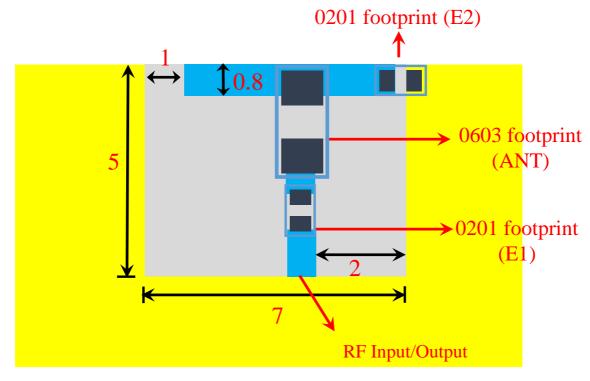




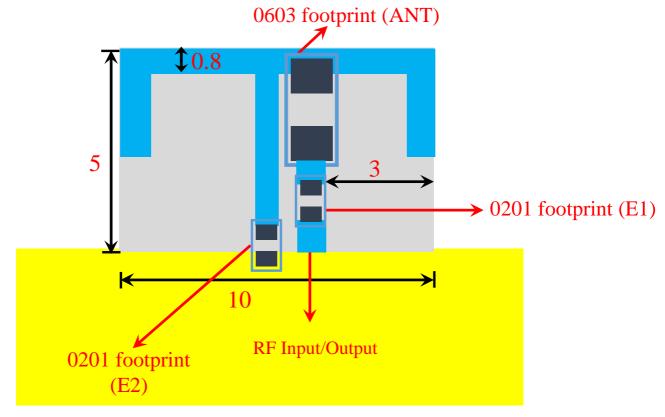


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✓ Layout-3 (5mm×7mm)



✓ Layout-4 (5mm×10mm)

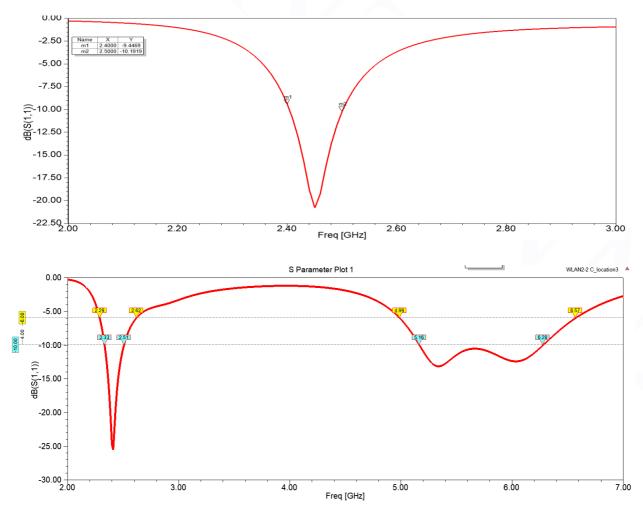


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✓ Electrical Characteristics:

	Feature	Specification		
1	Central frequency	2.45GHz		
2	Bandwidth	>150MHz		
3	Peak gain	2.78 dBi		
4	VSWR	<2		
5	Polarization	Linear		
6	Azimuth beamwidth	Omnidirectional		
7	Impedance	50 Ω		

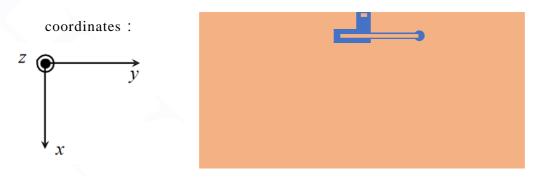
Characteristic Curves:

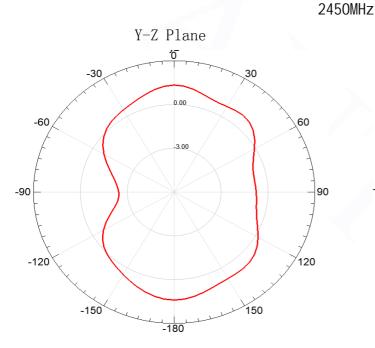


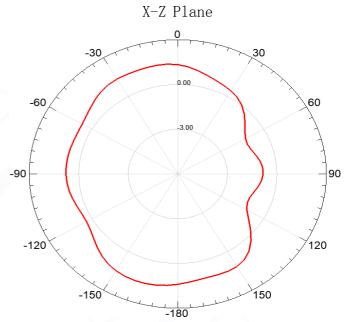
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✓ Radiation Pattern:







✓ Radiation Performance:

Frequency	2400MHz	2450MHz	2500MHz
Avg. gain	-1.92	-1.35	-1.56
Peak gain	1.79	2.78	2.66
Efficiency	74.55	80.25	76.98

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✓ Dependability Test

Test Temperature $25^{\circ}C \pm 5^{\circ}C$ Operating Temperature $-25^{\circ}C \sim +125^{\circ}C$ Temperature $5\sim 40^{\circ}C$ Relative Humidity $20\sim 70\%$

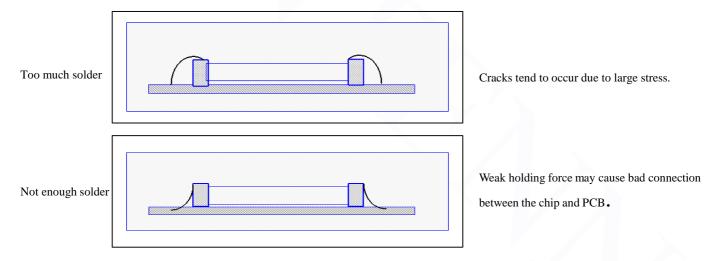
✓ Moisture Proof

Temperature: 40±2°C Humidity: 90~95%RH Duration: 500h Recovery conditions: Room temperature Recovery Time: 24h (Class1) or 48h (Class2)

Solderability

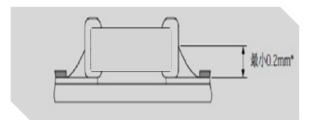
At least 95% of the terminal electrode is covered by new solder. Preheating conditions:80 to 120° C; $10 \sim 30$ s. Solder Temperature: $235 \pm 5^{\circ}$ C Duration: 2 ± 0.5 s, Solder Temperature: $245 \pm 5^{\circ}$ C Duration: 2 ± 0.5 s

Optimum Solder Amount for Reflow Soldering

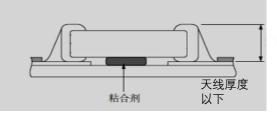


✓ Recommended Soldering Amounts

The optimal solder fillet amounts for re-flow soldering



The optimal solder fillet amounts for wave soldering



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Temperature Cycle Test

 $10\pm1S$ Applied Force: 5N Duration: $10\pm1S$ Preheating conditions: up-category temperature, 1h Recovery time: $24\pm1h$ Initial Measurement Cycling Times: 5 times, 1 cycle, 4 steps:

Stage	Temperature(°C)	Time (minutes)
Step 1	Lower temperature limit (NPOX7R/X75/X65/X5R-55) Y5V:25 Z5U:10	30
Step 2	normal atmospheric temperature(+20)	2-3
Step 3	Upper line temperature $\begin{pmatrix} NPO'X7R/X7S: +125 \\ Y5V/Z5UIX5R: +85 X68: +105 \end{pmatrix}$	30
Step 4	normal atmospheric temperature(+20)	2-3

Resistance to Soldering Heat

Preheating 80 to 120° C; $10 \sim 30$ s.SolderTemperature: $235\pm5^{\circ}$ C; Duration: 2 ± 0.5 s; SolderTemperature: $245\pm5^{\circ}$ C Duration: 2 ± 0.5 s; Preheating 100 to 200° C; 10 ± 2 min.

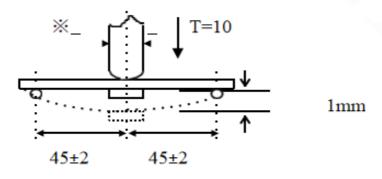
Solder Temperature: 265±5°C; Duration: 10±1s

Clean the capacitor with solvent and examine it with a 10X(min.) microscope.

Recovery Time: 24±2h

Recovery condition: Room temperature

✓ Resistance to Flexure of Substrate



Test Board: Al₂O₃ or PCB Warp: 1mm Speed: 0.5mm/sec. Unit: mm

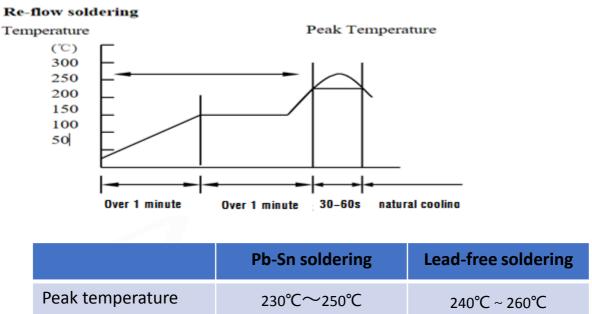
The measurement should be made with the board in the bending position.

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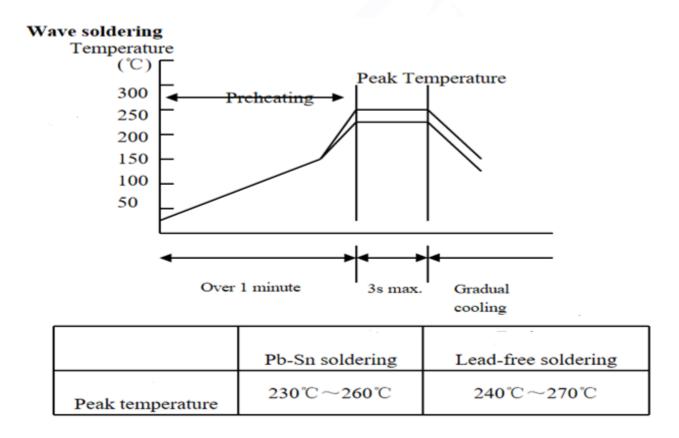
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The temperature profile for soldering

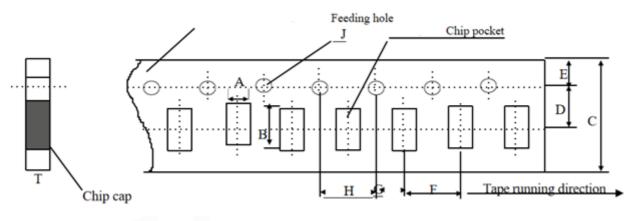
While in preheating, please keep the temperature difference between soldering temperature and surface temperature of chips as: T \leq 150°C.



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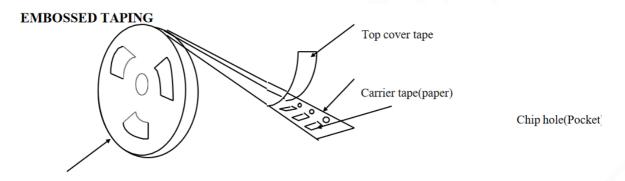
✓ Dimensions of paper taping



Unit: mm

Code	А	В	С	D*	E	F	G*	Н	J	Т
Cino	1.10	1.90	8.00	3.50	1.75	4.00	2.00	4.00	1.50	1.10
Size	±0.10	±0.10	±0.10	±0.05	±0.10	±0.10	±0.10	±0.10	-0/+0.10	Max

Reel (4000 pcs/Reel)



Polystyrene reel

✓ Storage Period

The guaranteed period for solderability is 6 months (Under deliver package condition). Temperature: $5\sim40^{\circ}$ C /Relative Humidity: $20\sim70\%$